

can u provide the exact step by step communications that happen in the sdk between os kernel hal external apps and the processors

The MCU+ SDK for AM62AX facilitates communication between different software layers and processor cores through a structured approach. Let me explain the step-by-step communication flow:

Communication Flow in MCU+ SDK

The communication between OS kernel, HAL, applications, and processors follows a layered architecture:

Application to OS Layer Communication

- 1. Applications first interact with the OS layer (No RTOS, FreeRTOS, or FreeRTOS POSIX)
- 2. For RTOS-based applications, this involves using OS primitives like tasks, semaphores, and timers
- 3. For No-RTOS applications, the execution environment provides basic timers, ISR handling, and a main thread for bare-metal operation [1]

OS to Driver Porting Layer (DPL)

- 1. The OS layer communicates with the Driver Porting Layer (DPL)
- 2. DPL abstracts the OS environment for the drivers, providing consistent APIs regardless of the underlying OS^[1]
- 3. DPL handles critical functions like:
 - Semaphore management
 - Hardware interrupt handling
 - Mutex operations
 - Clock services

DPL to Device Drivers and HAL

- 1. The DPL interfaces with both SOC Peripheral Drivers and Board Peripheral Drivers
- 2. SOC Peripheral Drivers handle on-chip components (I2C, GPIO, UART, etc.)
- 3. Board Peripheral Drivers manage external components on the development board (Flash, EEPROM, etc.) [1]

Inter-Processor Communication (IPC)

For communication between different processor cores (ARM M4F, R5F, A53), the SDK uses specific IPC mechanisms:

1. RPMessage-based communication:

- Uses a client-server model for message exchange
- Provides APIs for sending and receiving messages between CPUs
- When using Linux, this is implemented through the rpmsg_char character driver in user space or the rpmsg_char library [2]

2. IPC Notify:

- Allows sending smaller 28-bit message values
- Requires endpoint values to be less than IPC_NOTIFY_CLIENT_ID_MAX
- Used for simpler signaling between processors [2]

Hardware Access Flow

- 1. Applications request services from the OS layer
- 2. OS layer uses DPL to abstract hardware access
- 3. DPL communicates with appropriate device drivers
- 4. Device drivers interact with the physical hardware through register-level operations
- 5. For cross-processor communication, IPC mechanisms are employed to synchronize and exchange data $\frac{[2]}{}$

The SDK also includes the System Controller Interface (SCI) Client HAL which manages complex interactions between operating systems on heterogeneous SoCs for generic features and provides centralized knowledge of system state [3].

This layered approach ensures proper abstraction, portability across different OS environments, and efficient communication between software components and the underlying hardware.



- 1. https://software-dl.ti.com/mcu-plus-sdk/esd/AM62X/latest/exports/docs/api_guide_am62x/index.html
- 2. https://software-dl.ti.com/mcu-plus-sdk/esd/AM62AX/09_01_00_39/exports/docs/api_guide_am62ax/IPC_GUIDE.html
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